



DUAL SURFACE MOUNT TVS ARRAY

Product Summary

| V _{BR(Min)} | I _{PP(Max)} | C _{T(Max)} |
|----------------------|----------------------|---------------------|
| 5.3V | 20A | 220pF |

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in Automotive Infotainment applications.

- USB Modules
- HDMI Inputs
- Infotainment Consoles

Features and benefits

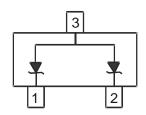
- Provides ESD Protection per IEC 61000-4-2 Standard: Air - ±16kV, Contact - ±9kV
- 2 Channels of ESD Protection
- 250W Peak Pulse Power
- Typically Used at Computers, Printers and Communication Systems
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.0089 grams (Approximate)



Top View



Device Schematic

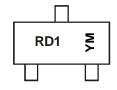
Ordering Information (Note 5)

| Part Number | Compliance | Marking | Reel Size(inches) | Tape Width(mm) | Quantity Per Reel |
|--------------|------------|---------|-------------------|----------------|-------------------|
| DESDA5V3LQ-7 | Automotive | RD1 | 7 | 8 | 3,000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



RD1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 9 = September)

Date Code Key

| Ye | ear | 201 | 7 | 2018 | | 2019 | 20 | 20 | 2021 | | 2022 | 2 | 2023 |
|----|-----|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Co | ode | Е | | F | | G | I | 1 | - | | J | | K |
| Мо | nth | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Co | de | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | Conditions |
|------------------------------------|--------------------------|-------|------|------------------------------|
| Peak Pulse Power Dissipation | P_PP | 250 | W | 8/20µs, Figure 2 |
| Peak Pulse Current | Ipp | 20 | Α | 8/20µs, Figure 2 |
| ESD Protection – Contact Discharge | V _{ESD_Contact} | ±9 | kV | Standard IEC 61000-4-2 |
| ESD Protection – Air Discharge | V _{ESD_Air} | ±16 | kV | Standard IEC 61000-4-2 |
| ESD Protection – Human Body Model | V_{HBM} | ±25 | kV | MIL STD 883C – Method 3015-6 |

Thermal Characteristics

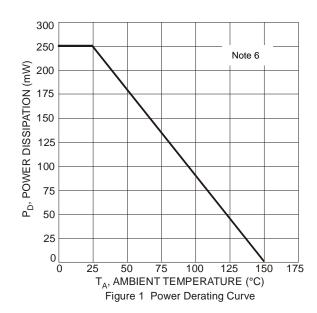
| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 6) | P_{D} | 250 | mW |
| Thermal Resistance, Junction to Ambient (Note 6) | $R_{	heta JA}$ | 500 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---------------------------|-----------------|-----|------|------|------|-----------------------------|
| Reverse Breakdown Voltage | V_{BR} | 5.3 | _ | 5.9 | V | $I_R = 1mA$ |
| Reverse Current (Note 7) | I _{RM} | 1 | _ | 2 | μA | $V_{RM} = 3V$ |
| Forward Voltage | VF | _ | _ | 1.25 | V | I _F = 200mA |
| Dynamic Resistance | R_D | 1 | 0.28 | _ | Ω | $Ipp = 15A, t_P = 2.5\mu s$ |
| Channel Input Capacitance | C _{IN} | _ | _ | 220 | pF | $V_{IN} = 0V$, $f = 1MHz$ |

Notes:

- 6. Device mounted on FR-4 PCB pad layout (2oz copper) as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 7. Short duration pulse test used to minimize self-heating effect.



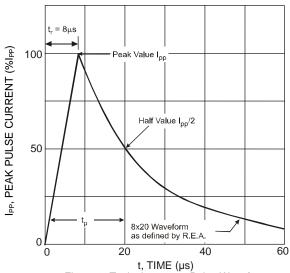


Figure 2 Typical 8 x 20µs Pulse Waveform



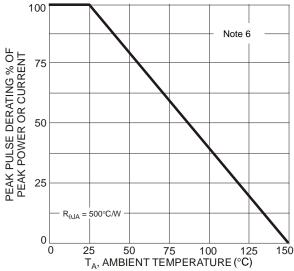
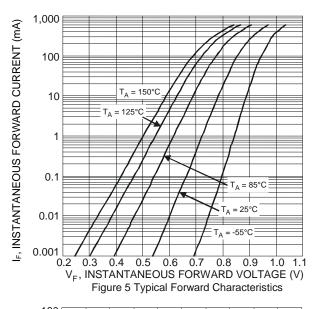


Figure 3 Power Dissipation vs. Ambient Temperature



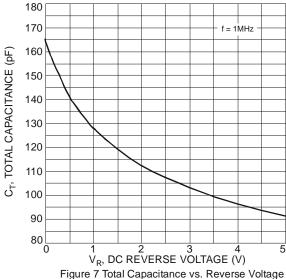
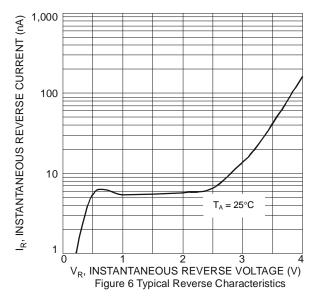


Figure 4 Max. Peak Pulse Power vs. Pulse Duration

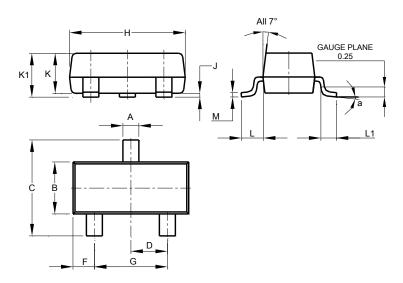




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

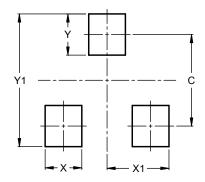


| SOT23 | | | | | | | |
|-------|--------|---------|-------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 0.37 | 0.51 | 0.40 | | | | |
| В | 1.20 | 1.40 | 1.30 | | | | |
| C | 2.30 | 2.50 | 2.40 | | | | |
| D | 0.89 | 1.03 | 0.915 | | | | |
| F | 0.45 | 0.60 | 0.535 | | | | |
| G | 1.78 | 2.05 | 1.83 | | | | |
| Н | 2.80 | 3.00 | 2.90 | | | | |
| J | 0.013 | 0.10 | 0.05 | | | | |
| K | 0.890 | 1.00 | 0.975 | | | | |
| K1 | 0.903 | 1.10 | 1.025 | | | | |
| L | 0.45 | 0.61 | 0.55 | | | | |
| L1 | 0.25 | 0.55 | 0.40 | | | | |
| М | 0.085 | 0.150 | 0.110 | | | | |
| а | 0° | 8° | | | | | |
| All | Dimens | ions in | mm | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 2.0 |
| Х | 0.8 |
| X1 | 1.35 |
| Y | 0.9 |
| Y1 | 2.0 |



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